

Product End-of-Life Disassembly Instructions

Product Category: Other Products

Marketing Name / Model

[List multiple models if applicable.]

HPE G2 R5000/6000 3U WW ERM

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HPE products to remove components and materials requiring selective treatment, as defined by EU directive 2012/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

Item Description	Notes	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq cm	2
Batteries	All types including standard alkaline and lithium coin or button style batteries	30
Mercury-containing components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries	0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps	0
Cathode Ray Tubes (CRT)		0
Capacitors / condensers (Containing PCB/PCT)		0
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height		0
External electrical cables and cords		0
Gas Discharge Lamps		0
Plastics containing Brominated Flame Retardants weighing > 25 grams (not including PCBs or PCAs already listed as a separate item above)		0
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations.	0
Components and waste containing asbestos		0
Components, parts and materials containing refractory ceramic fibers		0
Components, parts and materials containing		0

Item Description	Notes	Quantity of items included in product
radioactive substances		

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description	Tool Size (if applicable)
Star Head Screw Driver	M3
Cross Head Screw Driver	M3, M4
Plastic Nipper	Normal
Nut Driver	M4
Electric Iron	Normal

3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Remove the middle bezel, and then loosen the screws to remove the main panel..
2. Loosen screws on cover with Cross Head Screw Driver, and then take off the cover.
3. Loosen the screws fixing the battery door, remove the battery door, remove the wires from the battery terminal, and pull out the battery pack.
4. Remove the plastic cover from the battery pack, and then remove all the connected wires.
5. Loosen the screws on the rear panel. Separate panel from the main Frame.
6. Loosen the screws fixing the PCB and terminal, remove them.
7. Loosen the screws fixing the plates, remove them.

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

Batteries:

